

# HiPerFRED™ Epitaxial Diode

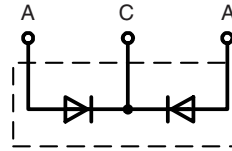
## with common cathode and soft recovery

$$I_{FAV} = 2 \times 10 \text{ A}$$

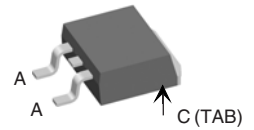
$$V_{RRM} = 1200 \text{ V}$$

$$t_{rr} = 40 \text{ ns}$$

| $V_{RSM}$<br>V | $V_{RRM}$<br>V | Type         |
|----------------|----------------|--------------|
| 1200           | 1200           | DSEC 16-12AS |



TO-263 AB



A = Anode, C/TAB = Cathode

| Symbol     | Conditions                                                                                     | Maximum Ratings |                  |
|------------|------------------------------------------------------------------------------------------------|-----------------|------------------|
| $I_{FRMS}$ | $T_C = 115^\circ\text{C}$ ; rectangular, $d = 0.5$                                             | 14              | A                |
| $I_{FAVM}$ |                                                                                                | 10              | A                |
| $I_{FSM}$  | $T_{VJ} = 45^\circ\text{C}$ ; $t_p = 10 \text{ ms}$ (50 Hz), sine                              | 40              | A                |
| $E_{AS}$   | $T_{VJ} = 25^\circ\text{C}$ ; non-repetitive<br>$I_{AS} = 8 \text{ A}$ ; $L = 180 \mu\text{H}$ | 6.9             | mJ               |
| $I_{AR}$   | $V_A = 1.25 \cdot V_R$ typ.; $f = 10 \text{ kHz}$ ; repetitive                                 | 0.8             | A                |
| $T_{VJ}$   | $T_C = 25^\circ\text{C}$                                                                       | -55...+175      | $^\circ\text{C}$ |
| $T_{VJM}$  |                                                                                                | 175             | $^\circ\text{C}$ |
| $T_{stg}$  |                                                                                                | -55...+150      | $^\circ\text{C}$ |
| $P_{tot}$  | $T_C = 25^\circ\text{C}$                                                                       | 60              | W                |
| $F_C$      | mounting force                                                                                 | 20...60         | N                |
| Weight     | typical                                                                                        | 2               | g                |

### Features

- International standard package
- Planar passivated chips
- Very short recovery time
- Extremely low switching losses
- Low  $I_{RM}$ -values
- Soft recovery behaviour
- Epoxy meets UL 94V-0

### Applications

- Antiparallel diode for high frequency switching devices
- Antisaturation diode
- Snubber diode
- Free wheeling diode in converters and motor control circuits
- Rectifiers in switch mode power supplies (SMPS)
- Inductive heating
- Uninterruptible power supplies (UPS)
- Ultrasonic cleaners and welders

### Advantages

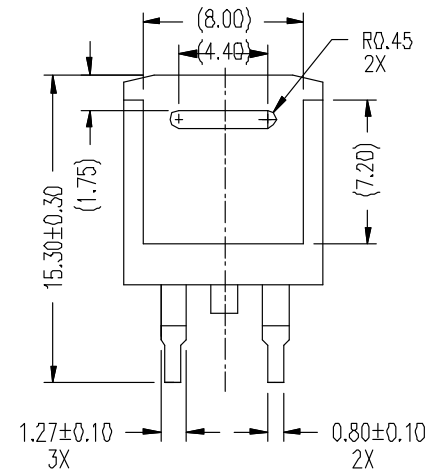
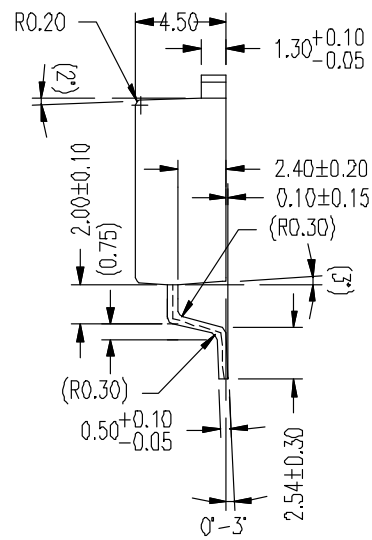
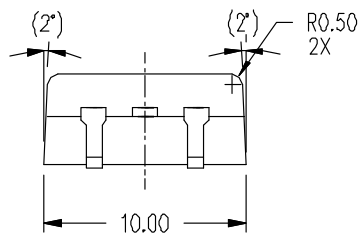
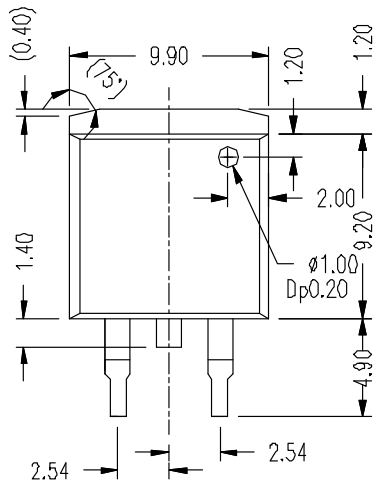
- Avalanche voltage rated for reliable operation
- Soft reverse recovery for low EMI/RFI
- Low  $I_{RM}$  reduces:
  - Power dissipation within the diode
  - Turn-on loss in the commutating switch

Dimensions see Outlines.pdf

| Symbol                   | Conditions                                                                                                            | Characteristic Values |                             |
|--------------------------|-----------------------------------------------------------------------------------------------------------------------|-----------------------|-----------------------------|
|                          |                                                                                                                       | typ.                  | max.                        |
| $I_R$ *                  | $T_{VJ} = 25^\circ\text{C}$ $V_R = V_{RRM}$<br>$T_{VJ} = 150^\circ\text{C}$ $V_R = V_{RRM}$                           |                       | 60 $\mu\text{A}$<br>0.25 mA |
| $V_F$ *                  | $I_F = 10 \text{ A}$ ; $T_{VJ} = 150^\circ\text{C}$<br>$T_{VJ} = 25^\circ\text{C}$                                    |                       | 1.96 V<br>2.94 V            |
| $R_{thJC}$<br>$R_{thCH}$ |                                                                                                                       | 0.5                   | 2.5 K/W<br>K/W              |
| $t_{rr}$                 | $I_F = 1 \text{ A}$ ; $-di/dt = 50 \text{ A}/\mu\text{s}$ ;<br>$V_R = 30 \text{ V}$ ; $T_{VJ} = 25^\circ\text{C}$     | 40                    | ns                          |
| $I_{RM}$                 | $V_R = 100 \text{ V}$ ; $I_F = 12 \text{ A}$ ; $-di_F/dt = 100 \text{ A}/\mu\text{s}$<br>$T_{VJ} = 100^\circ\text{C}$ |                       | 8.5 A                       |

Pulse test: \* Pulse Width = 5 ms, Duty Cycle < 2.0%  
\* Pulse Width = 300  $\mu\text{s}$ , Duty Cycle < 2.0%

Data according to IEC 60747 and per diode unless otherwise specified



NOTE:

1. These dimensions do not include mald protrusion.
2. ( ) is reference dimension only.

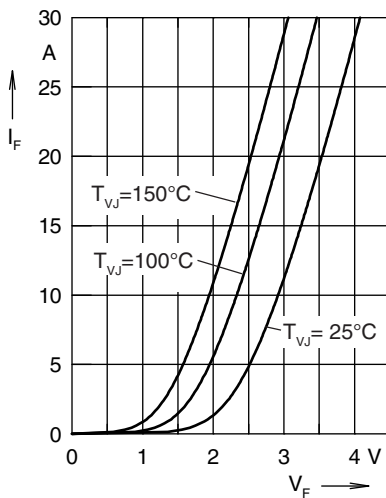


Fig. 1 Forward current  $I_F$  versus  $V_F$

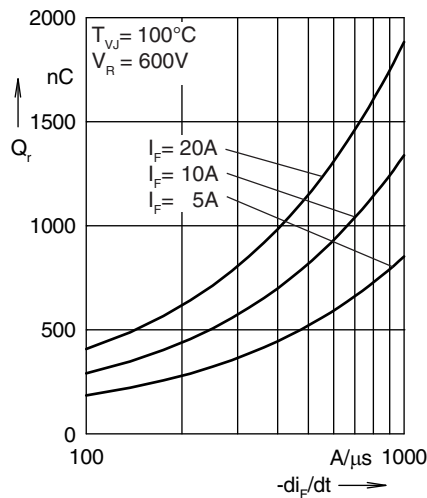


Fig. 2 Reverse recovery charge  $Q_r$  versus  $-di_F/dt$

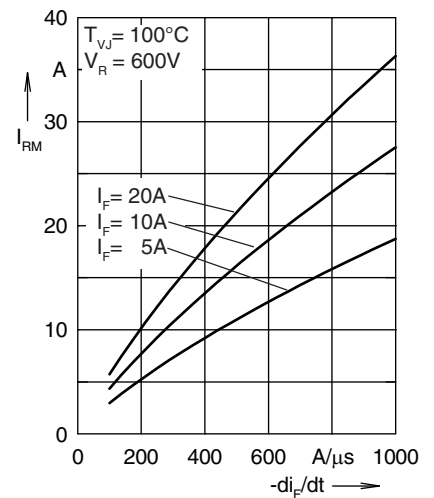


Fig. 3 Peak reverse current  $I_{RM}$  versus  $-di_F/dt$

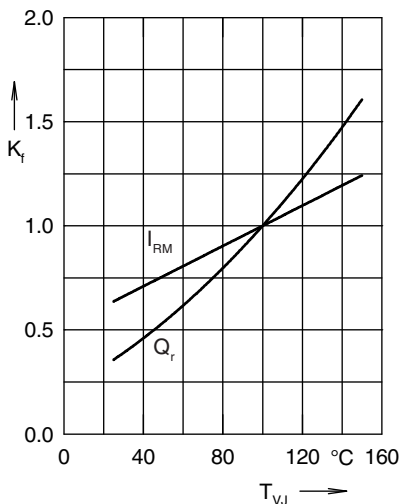


Fig. 4 Dynamic parameters  $Q_r$ ,  $I_{RM}$  versus  $T_{VJ}$

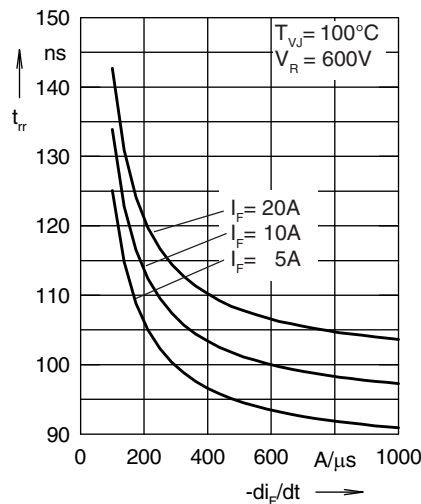


Fig. 5 Recovery time  $t_{rr}$  versus  $-di_F/dt$

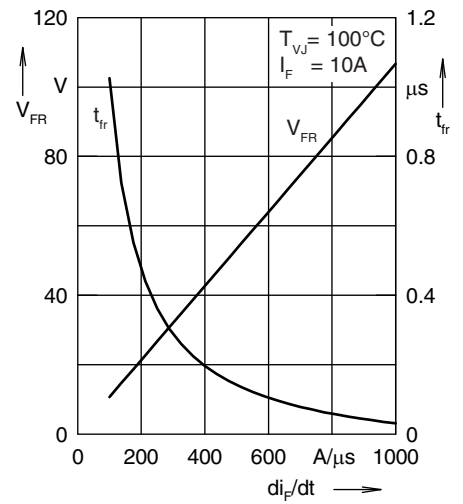


Fig. 6 Peak forward voltage  $V_{FR}$  and  $t_{fr}$  versus  $di_F/dt$

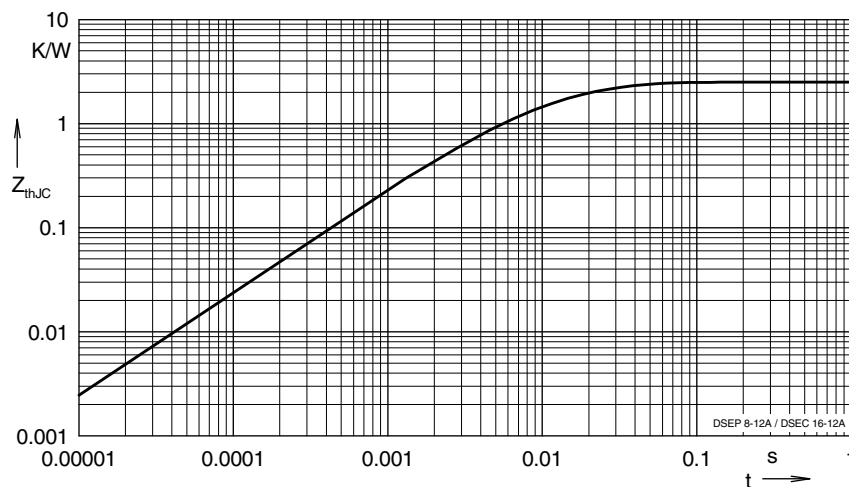


Fig. 7 Transient thermal resistance junction to case

Constants for  $Z_{thJC}$  calculation:

| i | $R_{thi}$ (K/W) | $t_i$ (s) |
|---|-----------------|-----------|
| 1 | 1.449           | 0.0052    |
| 2 | 0.558           | 0.0003    |
| 3 | 0.493           | 0.017     |